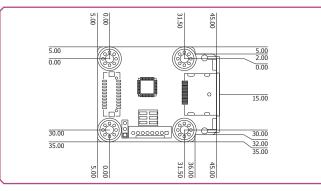


EXT-DP



Mechanical Drawing



Features

CHIP	SN75DP130
PORT	1 DP
INTERFACE	DP
DIMENSIONS	50mm x 40mm (1.97" x 1.57")

Specifications

CHIP

• Re-Driver SN75DP130

FEATURES

- Supports DP v1.1a and DP v1.2 signaling including HBR Data rates to 2.7Gbps
- **REAR PANEL I/O PORT**

• 1 DP port

I/O CONNECTORS

- 1 DP connector
- 1 LCD/Inverter power connector

APPLIED MODELS

• HU171/173, HU101/103, HM100/101/103-QM87/HM86

TEMPERATURE

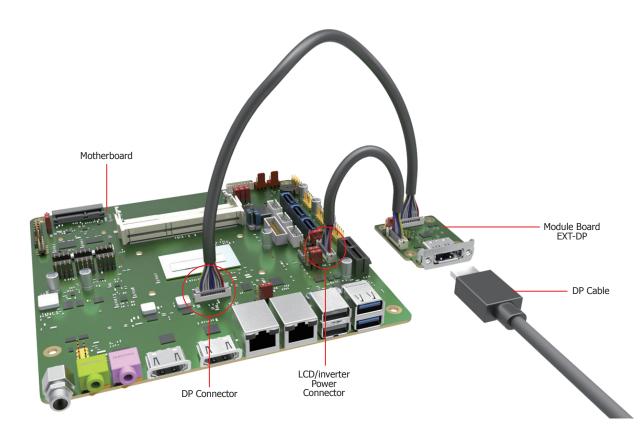
- Operating: 0°C to 60°C
 Storage: -20°C to 85°C

HUMIDITY

• 5% to 90%

DIMENSIONS

• 50mm x 40mm (1.97" x 1.57")



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